

Application Data Sheet

APPLICATION INFORMATION

Application Number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?: None

Number of CD Disks:

Number of Copies of CDs::

Sequence Submission?:

Computer Readable From (CRF)?: No

Number of Copies of CRF::

Title:: SEMICONDUCTOR DEVICE HAVING LOW-K
DIELECTRIC FILM IN PAD REGION AND
METHOD FOR MANUFACTURING THEREOF

Attorney Docket Number:: 403013

Request for Early Publication?: No

Request for Non-Publication?: No

Suggested Drawing Figure::

Total Drawing Sheets:: 3

Small Entity?: No

Latin Name::

Variety denomination name::

Petition Included?: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Appl.?: No

APPLICANT INFORMATION

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Korea
Status:: Full Capacity
Given Name:: Hong-Jae
Middle Name::
Family Name:: SHIN
Name Suffix::
City of Residence::
State or Prov. of Residence::
Country of Residence:: Japan
Street of mailing address:: c/o Semiconductor Leading Edge
Technologies, Inc.
16-1 Onogawa
City of mailing address:: Tsukuba-shi
State or Province of mailing address:: Ibaraki
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 305-8569

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 23548
Phone:: (202) 737-6770
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REPRESENTATIVE INFORMATION

Representative Customer Number:: 23548

Representative Designation:: Registration Number:: Representative Name::

DOMESTIC PRIORITY INFORMATION

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

FOREIGN APPLICATION INFORMATION

Country::	Application Number::	Filing Date::	Priority Claimed
Japan	2003-087805	03/27/03	Yes

ASSIGNEE INFORMATION

Assignee name:: Semiconductor Leading Edge Technologies, Inc.

Street of mailing address:: 16-1 Onogawa

City of mailing address:: Tsukuba-shi

State or Province of
mailing address:: Ibaraki

Country of mailing
address:: Japan

Postal or Zip Code of
mailing address:: 305-8569